



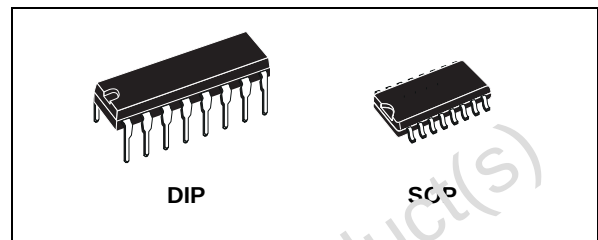
HCF40161B

SYNCHRONOUS PROGRAMMABLE 4-BIT BINARY COUNTER WITH ASYNCHRONOUS CLEAR

- INTERNAL LOOK-AHEAD FOR FAST COUNTING
- CARRY OUTPUT FOR CASCADING
- SYNCHRONOUSLY PROGRAMMABLE
- LOW-POWER TTL COMPATIBILITY
- STANDARDIZED SYMMETRICAL OUTPUT CHARACTERISTICS
- QUIESCENT CURRENT SPECIF. UP TO 20V
- 5V, 10V AND 15V PARAMETRIC RATINGS
- INPUT LEAKAGE CURRENT
 $I_l = 100\text{nA}$ (MAX) AT $V_{DD} = 18\text{V}$ $T_A = 25^\circ\text{C}$
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC JESD13B "STANDARD SPECIFICATIONS FOR DESCRIPTION OF B SERIES CMOS DEVICES"

DESCRIPTION

HCF40161B is a monolithic integrated circuit fabricated in Metal Oxide Semiconductor technology available in DIP and SOP packages. HCF40161B is a 4-bit synchronous programmable counter. The **CLEAR** function is asynchronous. A low level at the **CLEAR** input sets all four outputs low regardless of the state of the **CLOCK**, **LOAD** and **ENABLE** inputs. A low level at the **LOAD** inputs disables the counter and causes the output to agree with the set-up data after the following **CLOCK** pulse regardless of the conditions of the

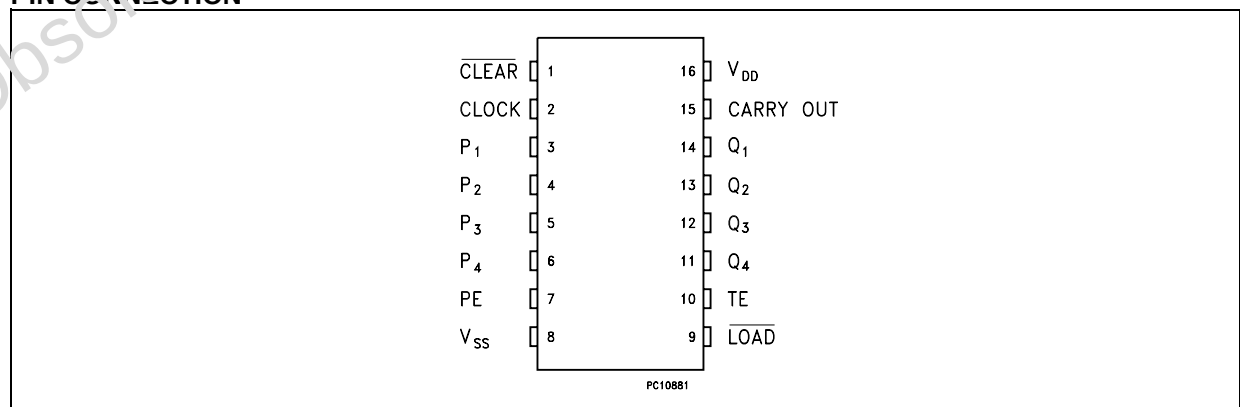


ORDER CODES

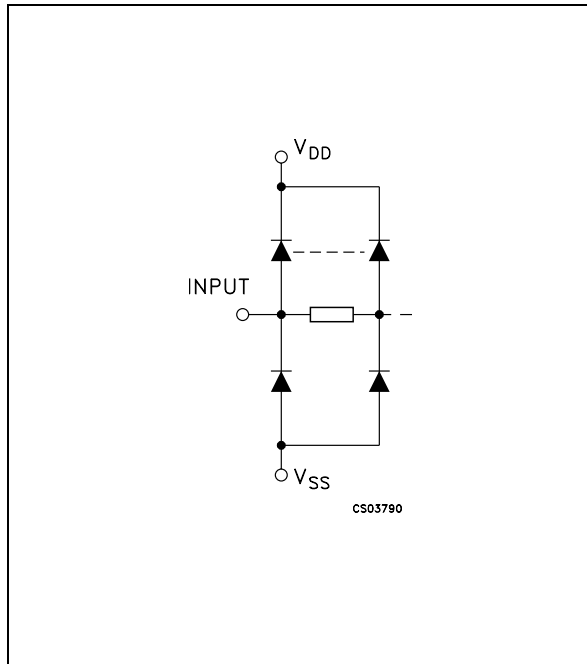
PACKAGE	TUBE	T & R
DIP	HCF40161BEY	
SOP	HCF40161BM1	HCF40161M013TR

ENABLE inputs. The carry look-ahead circuitry provides for cascading counter for n-bit synchronous application without additional gating. Counting is enabled when both the **PE** and **TE** inputs are high. The **TE** input is fed forward to enable **COUT**. This enable output produces a positive output pulse with a duration approximately equal to the positive portion of the **Q1** output. This positive overflow carry pulse can be used to enable successive cascaded stages. Logic transitions at the **PE** and **TE** inputs may occur when the clock is either high or low.

PIN CONNECTION



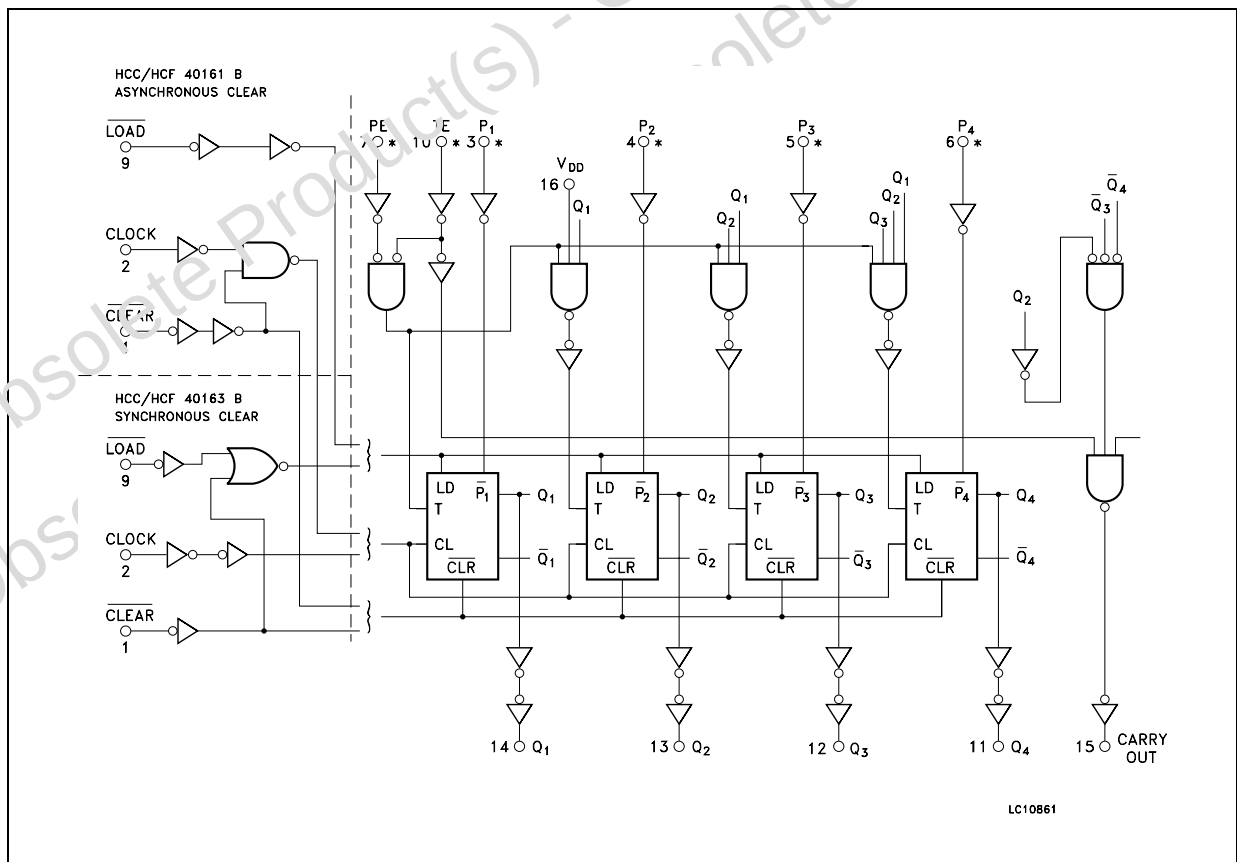
INPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
1	$\overline{\text{CLEAR}}$	Asynchronous Master Reset
2	CLOCK	Clock Input (LOW to HIGH, Edge-triggered)
3, 4, 5, 6	P1 to P4	Data Inputs
7	PE	Count Enable Input
10	TE	Count Enable Carry Input
9	$\overline{\text{LOAD}}$	Parallel Enable Input
14, 13, 12, 11	Q1 to Q4	Flip Flop Outputs
15	CARRY OUT	Terminal Count Output
8	V_{SS}	Negative Supply Voltage
16	V_{DD}	Positive Supply Voltage

LOGIC DIAGRAM

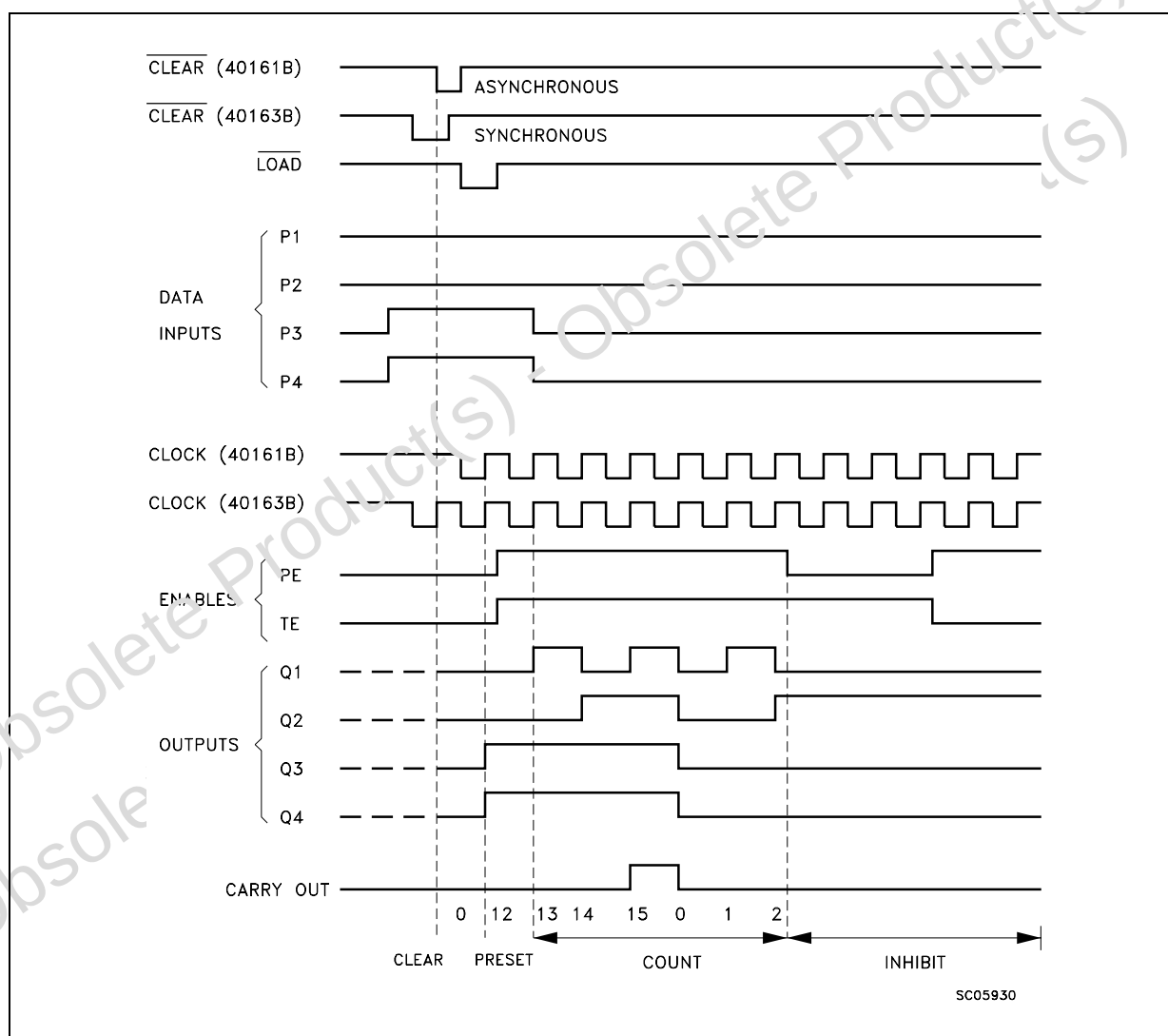


TRUTH TABLE

CLOCK	$\overline{\text{CLR}}$	$\overline{\text{LOAD}}$	PE	TE	OPERATION
	H	L	X	X	PRESET
	H	H	L	X	NC
	H	H	X	L	NC
	H	H	H	H	COUNT
X	L	X	X	X	RESET

(X) : Don't Care
NC : No Change

TIMING DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{DD}	Supply Voltage	-0.5 to +22	V
V_I	DC Input Voltage	-0.5 to $V_{DD} + 0.5$	V
I_I	DC Input Current	± 10	mA
P_D	Power Dissipation per Package	200	mW
	Power Dissipation per Output Transistor	100	mW
T_{op}	Operating Temperature	-55 to +125	°C
T_{stg}	Storage Temperature	-65 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All voltage values are referred to V_{SS} pin voltage.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{DD}	Supply Voltage	3 to 20	V
V_I	Input Voltage	0 to V_{DD}	V
T_{op}	Operating Temperature	-55 to 125	°C

DC SPECIFICATIONS

Symbol	Parameter	Test Condition				Value								Unit
		V _I (V)	V _O (V)	I _{OL} (μA)	V _{DD} (V)	T _A = 25°C			-40 to 85°C		-55 to 125°C			
						Min.	Typ.	Max.	Min.	Max.	Min.	Max.		
I _L	Quiescent Current	0/5			5		0.04	5		150		150	μA	
		0/10			10		0.04	10		300		300		
		0/15			15		0.04	20		600		600		
		0/20			20		0.08	100		3000		3000		
V _{OH}	High Level Output Voltage	0/5		<1	5	4.95			4.95		4.95		V	
		0/10		<1	10	9.95			9.95		9.95			
		0/15		<1	15	14.95			14.95		14.95			
V _{OL}	Low Level Output Voltage	5/0		<1	5		0.05			0.05		0.05	V	
		10/0		<1	10		0.05			0.05		0.05		
		15/0		<1	15		0.05			0.05		0.05		
V _{IH}	High Level Input Voltage		0.5/4.5	<1	5	3.5			3.5		3.5		V	
			1/9	<1	10	7			7		7			
			1.5/13.5	<1	15	11			11		11			
V _{IL}	Low Level Input Voltage		4.5/0.5	<1	5			1.5		1.5		1.5	V	
			9/1	<1	10			3		3		3		
			13.5/1.5	<1	15			4		4		4		
I _{OH}	Output Drive Current	0/5	2.5	<1	5	-1.36	-3.2		-1.1		-1.1		mA	
		0/5	4.6	<1	5	-0.44	-1		-0.36		-0.36			
		0/10	9.5	<1	10	-1.1	-2.6		-0.9		-0.9			
		0/15	13.5	<1	15	-3.0	-6.8		-2.4		-2.4			
I _{OL}	Output Sink Current	0/5	0.1	<1	5	0.44	1		0.36		0.36		mA	
		0/10	0.5	<1	10	1.1	2.6		0.9		0.9			
		0/15	1.5	<1	15	3.0	6.8		2.4		2.4			
I _I	Input Leakage Current	0/18	Any Input		18		±10 ⁻⁵	±0.1		±1		±1	μA	
C _I	Input Capacitance		Any Input				5	7.5					pF	

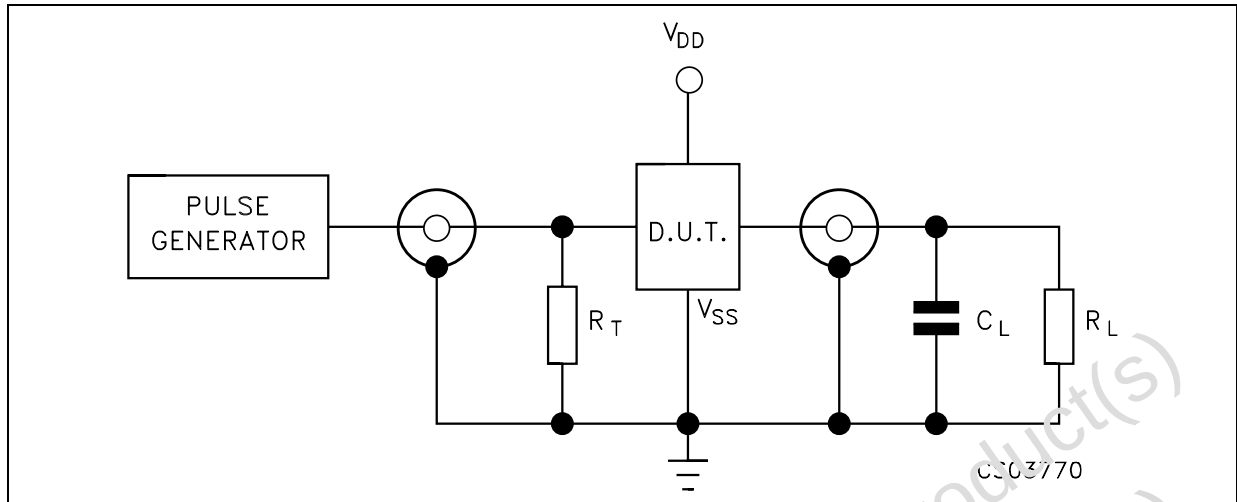
The Noise Margin for both "1" and "0" level is: 1V min. with V_{DD}=5V, 2V min. with V_{DD}=10V, 2.5V min. with V_{DD}=15V

DYNAMIC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$, $C_L = 50\text{pF}$, $R_L = 200\text{K}\Omega$, $t_r = t_f = 20\text{ ns}$)

Symbol	Parameter	Test Condition		Value (*)			Unit
		V_{DD} (V)		Min.	Typ.	Max.	
t_{PLH} t_{PHL}	Propagation Delay Time Clock to Q	5			200	400	ns
		10			80	160	
		15			60	120	
t_{PLH} t_{PHL}	Propagation Delay Time Clock to C_{OUT}	5			225	450	ns
		10			95	190	
		15			70	140	
t_{PLH} t_{PHL}	Propagation Delay Time TE to C_{OUT}	5			125	250	ns
		10			55	110	
		15			40	80	
t_{setup}	Setup Time Data to Clock	5		240	120		ns
		10		90	45		
		15		60	30		
t_{setup}	Setup Time Load to Clock	5		240	120		ns
		10		90	45		
		15		60	30		
t_{setup}	Setup Time PE or TE to Clock	5		340	170		ns
		10		140	70		
		15		100	50		
t_{hold}	Hold Time	5		0			ns
		10		0			
		15		0			
t_{THL} t_{TLH}	Transition Time	5			100	200	ns
		10			50	100	
		15			40	80	
t_W	Clock Input Pulse Width	5		170	85		ns
		10		70	35		
		15		50	25		
f_{CL}	Maximum Clock Input Frequency	5		2	3		MHz
		10		5.5	8.5		
		15		8	12		
t_r t_f	Clock Input Rise or Fall Time	5				200	ns
		10				70	
		15				15	
t_{PHL}	Propagation Delay Time Clear to Q	5			250	500	ns
		10			110	220	
		15			80	160	
t_W	Clear Input Pulse Width Low Level	5		170	85		ns
		10		70	35		
		15		50	25		

(*) Typical temperature coefficient for all V_{DD} value is 0.3 %/°C.

TEST CIRCUIT

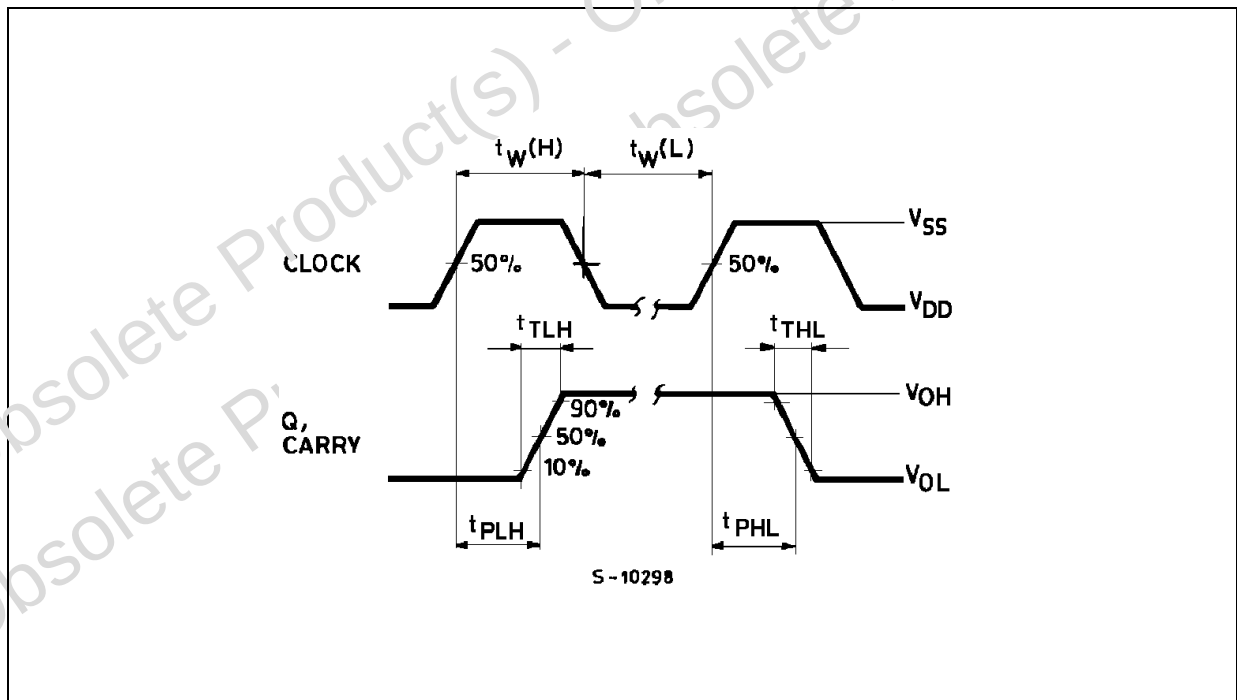


$C_L = 50\text{pF}$ or equivalent (includes jig and probe capacitance)

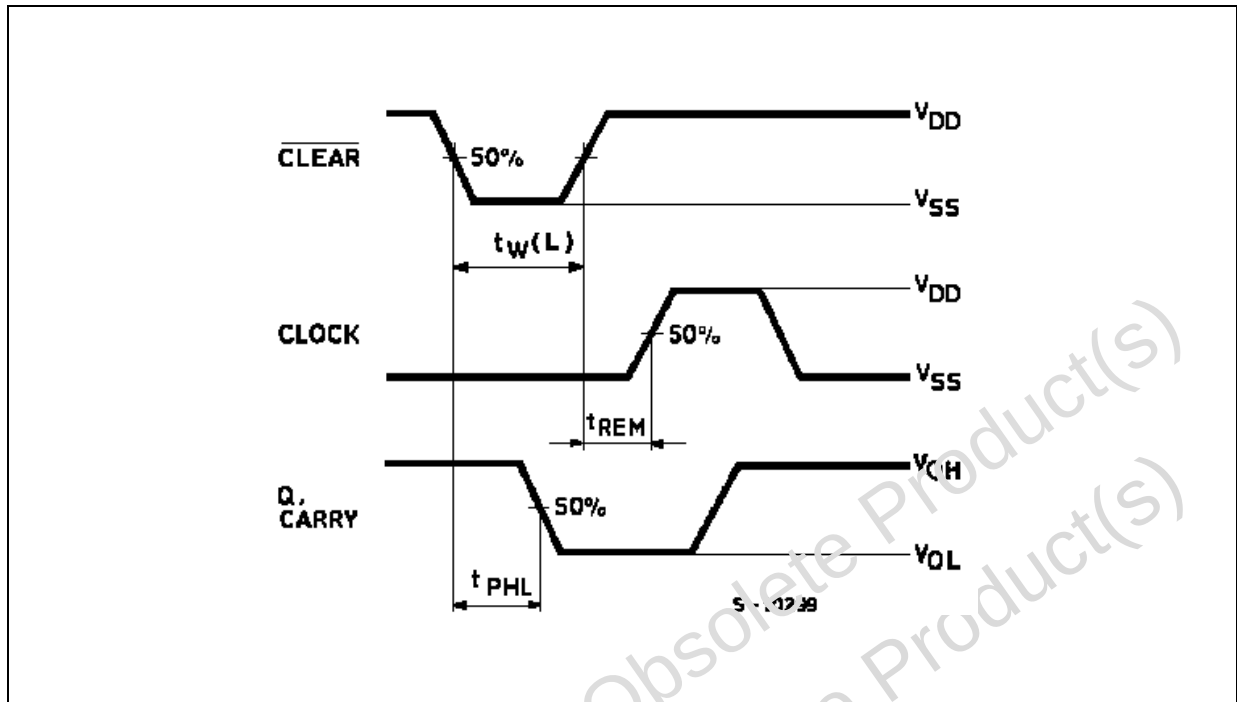
$R_L = 200\text{K}\Omega$

$R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

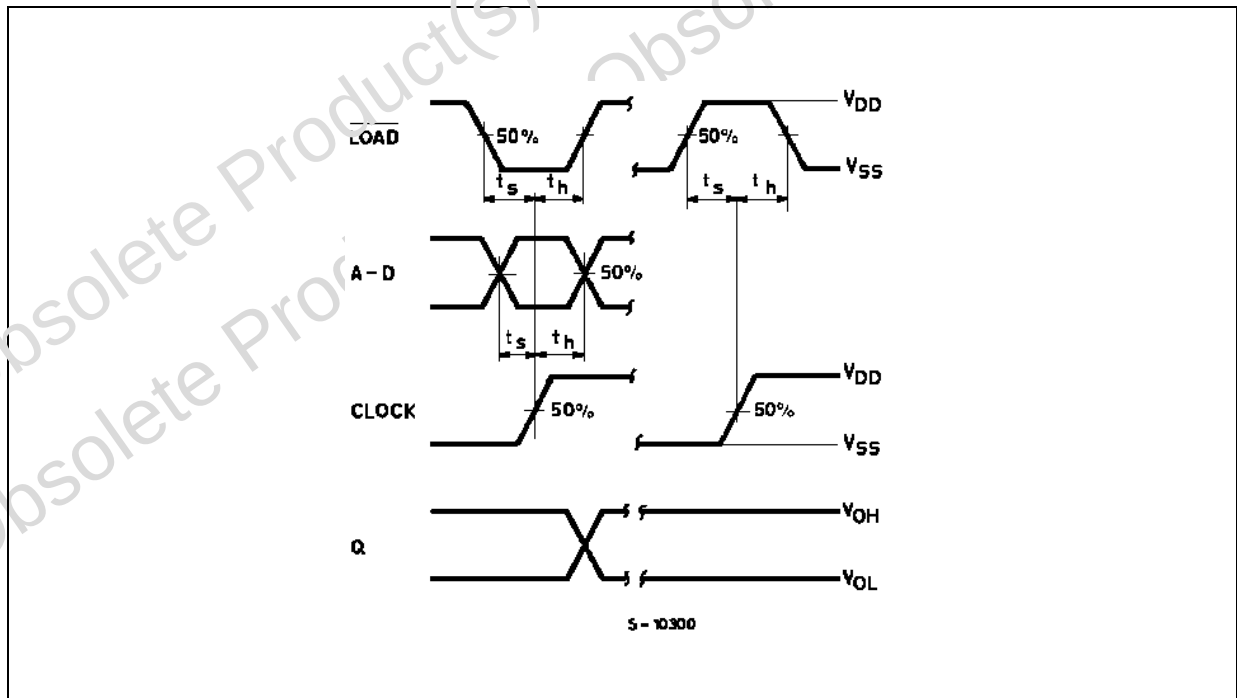
WAVEFORM 1 : PROPAGATION DELAY TIMES, CLOCK MINIMUM PULSE WIDTH ($f=1\text{MHz}$; 50% duty cycle)

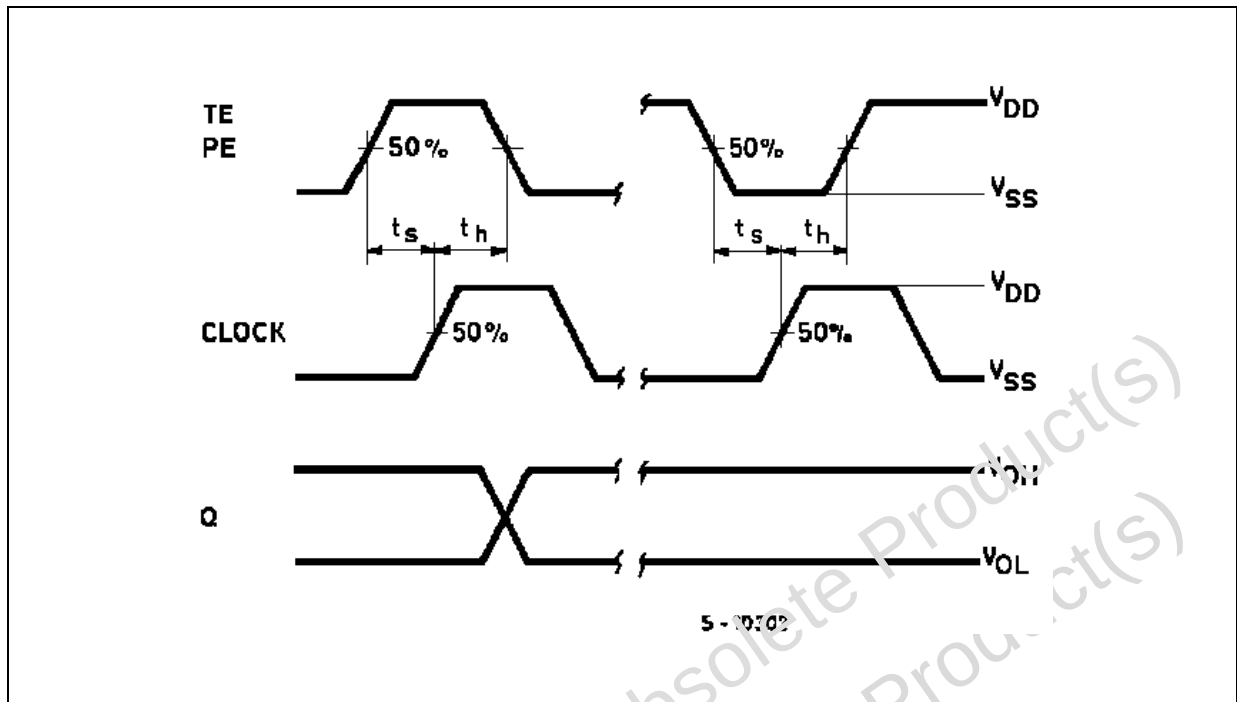
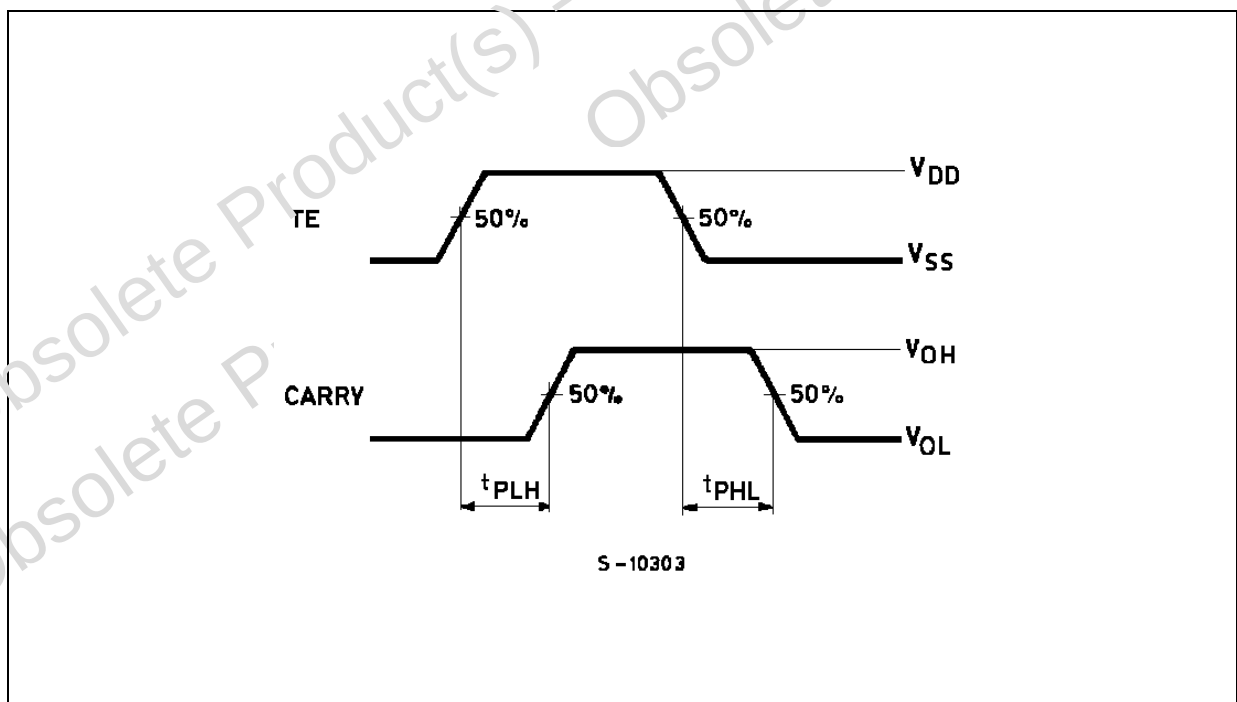


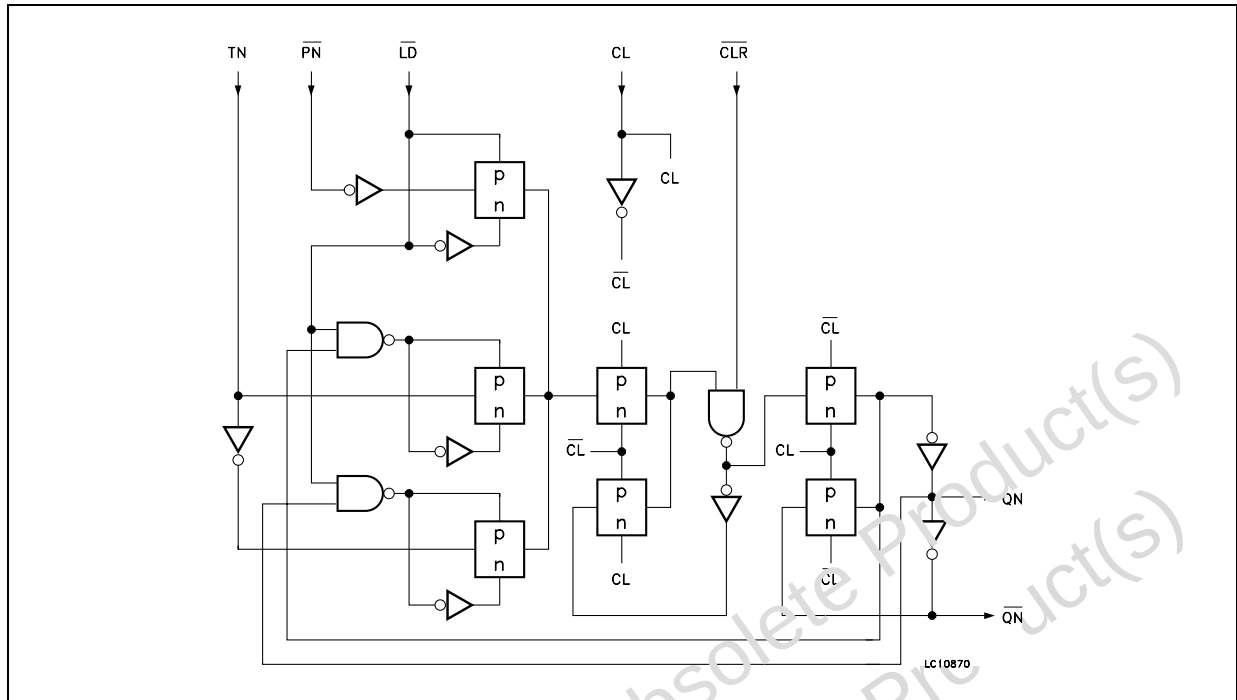
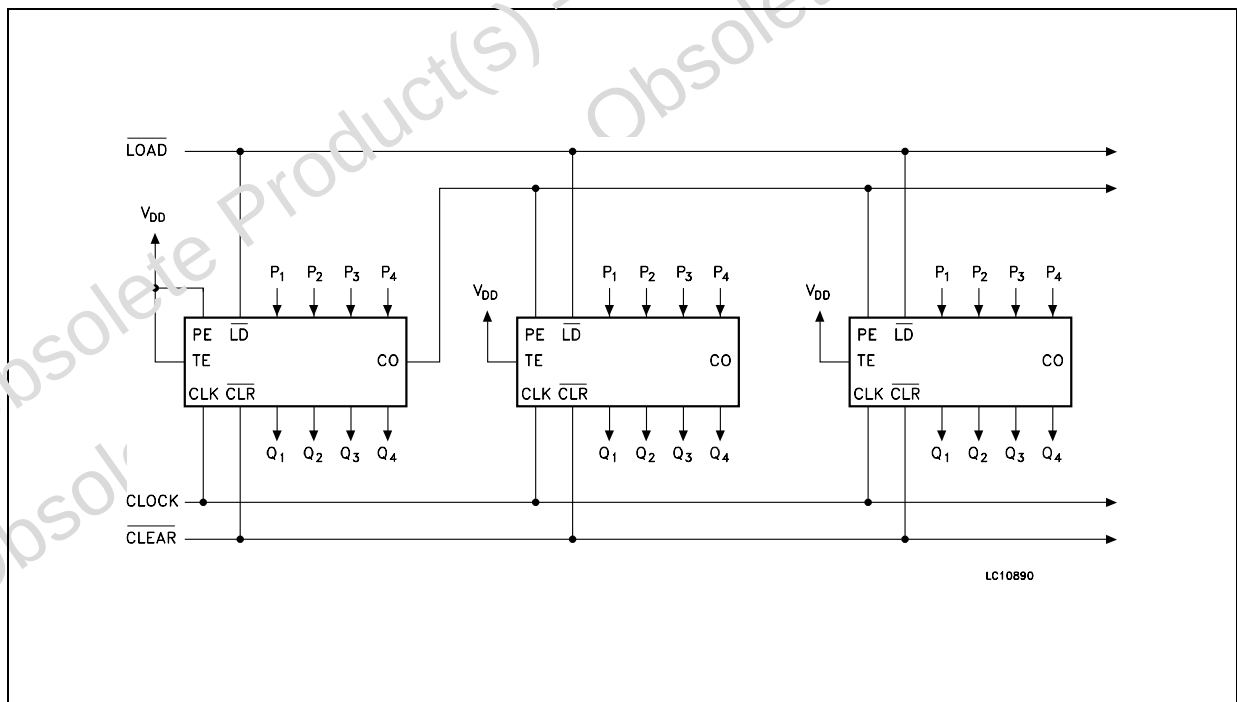
WAVEFORM 2 : PROPAGATION DELAY TIMES, $\overline{\text{CLEAR}}$ MINIMUM PULSE WIDTH (CLEAR MODE)
 (f=1MHz; 50% duty cycle)

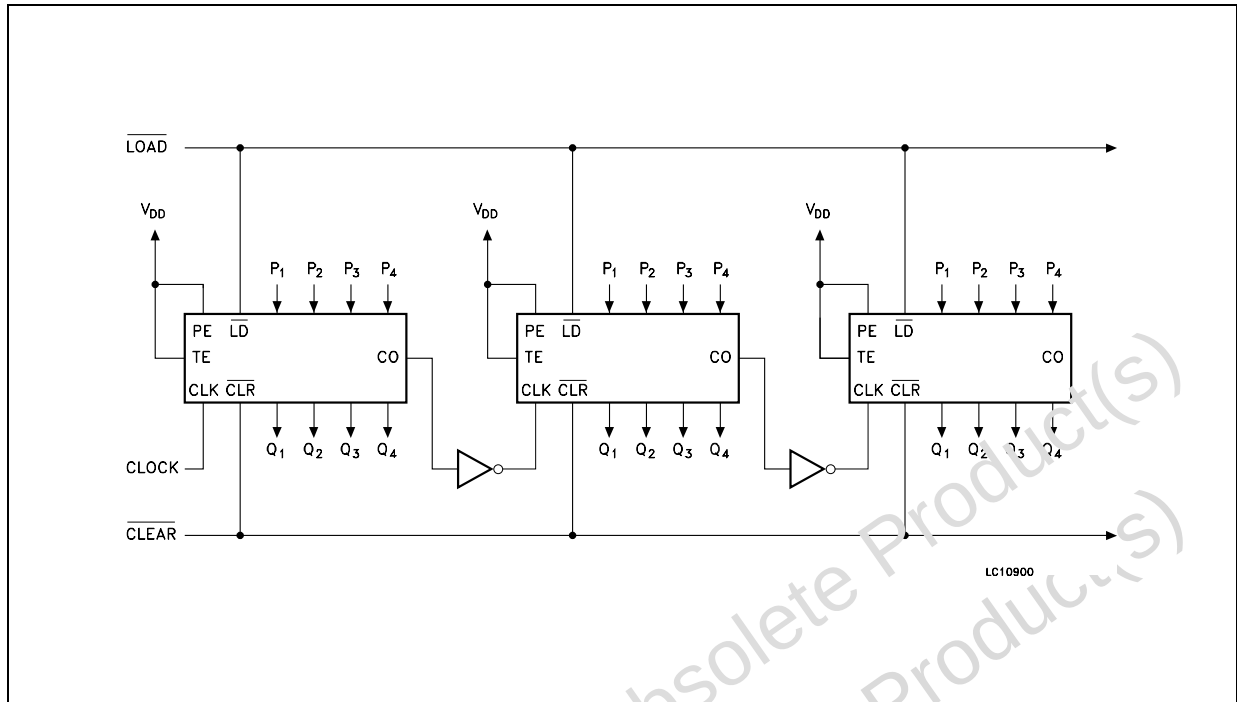


WAVEFORM 3 : SETUP AND HOLD TIMES (PRESET MODE) (f=1MHz; 50% duty cycle)



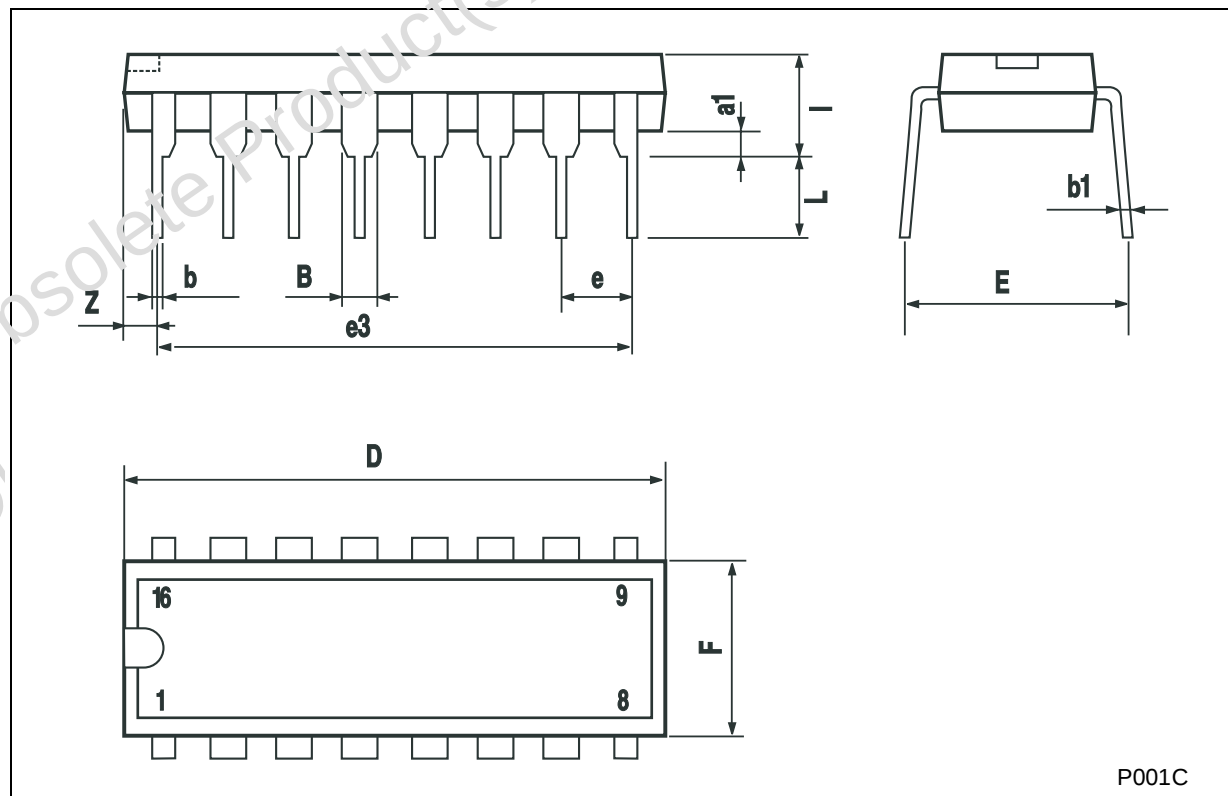
WAVEFORM 4 : SETUP AND HOLD TIMES (COUNTENABLE MODE) ($f=1\text{MHz}$; 50% duty cycle)**WAVEFORM 5 : PROPAGATION DELAY TIMES (CASCADE MODE)** ($f=1\text{MHz}$; 50% duty cycle)

TYPICAL APPLICATION: DETAIL OF FLIP-FLOPS (Asynchronous Clear)**TYPICAL APPLICATION: CASCADING COUNTER PACKAGES IN THE PARALLEL-CLOCKED MODE**

TYPICAL APPLICATION: CASCADING COUNTER PACKAGES IN THE RIPPLE-CLOCKED MODE

Plastic DIP-16 (0.25) MECHANICAL DATA

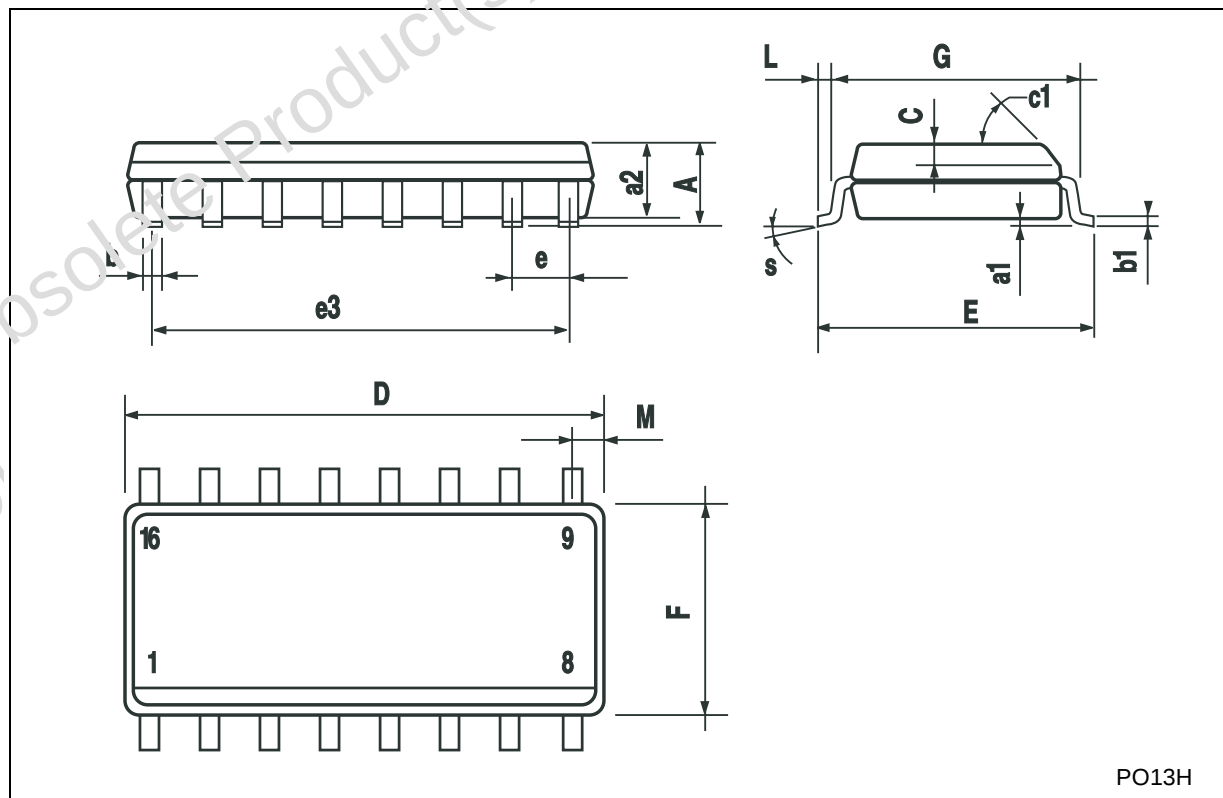
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050



P001C

SO-16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	9.8		10	0.385		0.393
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.62			0.024
S	8° (max.)					



PO13H

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